

Important notice

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In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

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If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

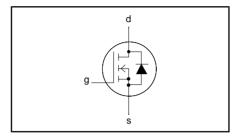
Team Nexperia

PHT6NQ10T

FEATURES

- 'Trench' technology
- Low on-state resistance
- Fast switching
- Low thermal resistance

SYMBOL



QUICK REFERENCE DATA

$$V_{DSS}$$
 = 100 V I_{D} = 6.5 A $R_{DS(ON)} \le 90 \text{ m}\Omega$

GENERAL DESCRIPTION

N-channel enhancement mode field-effect transistor in a plastic envelope using 'trench' technology.

Applications:-

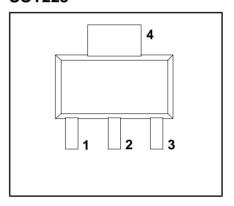
- Motor and relay drivers
- d.c. to d.c. converters

The PHT6NQ10T is supplied in the SOT223 surface mounting package.

PINNING

PIN	DESCRIPTION	
1	gate	
2	drain	
3	source	
4	drain (tab)	

SOT223



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DSS}	Drain-source voltage	$T_i = 25 ^{\circ}\text{C} \text{ to } 150 ^{\circ}\text{C}$	-	100	V
V_{DGR}	Drain-gate voltage	$T_i = 25 ^{\circ}\text{C} \text{ to } 150 ^{\circ}\text{C}; R_{GS} = 20 \text{k}\Omega$	-	100	V
V_{GS}	Gate-source voltage	,	-	± 20	V
I _D	Continuous drain current (dc)	$T_{sp} = 25 ^{\circ}C$	-	6.5	Α
		$T_{amb} = 25 ^{\circ}C$	-	3	Α
I _D	Continuous drain current (dc)	$T_{sp} = 100 ^{\circ}C$	-	4.1	Α
		$T_{amb} = 100 ^{\circ}C$	-	1.9	Α
I _{DM}	Pulsed drain current		-	26	Α
P_{D}	Total power dissipation	$T_{sp} = 25 ^{\circ}C$	-	8.3	W
		$T_{sp} = 25 ^{\circ}\text{C}$ $T_{amb} = 25 ^{\circ}\text{C}$	-	1.8	W
T_j , T_{stg}	Operating junction and storage temperature		- 65	150	°C

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
R _{th j-sp}	Thermal resistance junction to solder point	surface mounted, FR4 board	12	15	K/W
R _{th j-amb}	Thermal resistance junction to ambient	surface mounted, FR4 board	70	-	K/W

Philips Semiconductors Product specification

N-channel TrenchMOSTM transistor

PHT6NQ10T

ELECTRICAL CHARACTERISTICS

T_i= 25°C unless otherwise specified

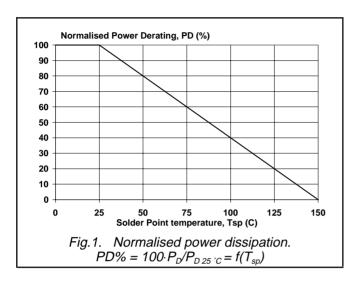
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	Drain-source breakdown	$V_{GS} = 0 \text{ V}; I_D = 0.25 \text{ mA};$	100	-	-	V
.,	voltage	$T_j = -55^{\circ}C$	89	-	-	V
$V_{GS(TO)}$	Gate threshold voltage	$V_{DS} = V_{GS}; I_D = 1 \text{ mA}$	2	3	4	V
		T _j = 150°C T _i = -55°C	1.2	-	-	V V
R	Drain-source on-state	$V_{GS} = 10 \text{ V}; I_D = 3 \text{ A}$	_	57	6 90	$\begin{array}{ c c c c c c c c c c c c c c c c c c c$
$R_{DS(ON)}$	resistance	$T_{i} = 150^{\circ}C$	_	37	216	mΩ
I _{GSS}	Gate source leakage current	$V_{GS} = \pm 10 \text{ V}; V_{DS} = 0 \text{ V}$	-	10	100	nA
I _{DSS}	Zero gate voltage drain	$V_{DS} = 100 \text{ V}; V_{GS} = 0 \text{ V};$	-	0.05	10	μΑ
D33	current	$T_j = 150^{\circ}C$	-	-	500	μΑ
$Q_{g(tot)}$	Total gate charge	$I_D = 6 \text{ A}; V_{DD} = 80 \text{ V}; V_{GS} = 10 \text{ V}$	-	21	-	nC
Q _{gs}	Gate-source charge		-	2.5	-	nC
Q_{gd}	Gate-drain (Miller) charge		-	8.2	-	nC
t _{d on}	Turn-on delay time	$V_{DD} = 50 \text{ V}; R_D = 8.2 \Omega;$	-	6	-	ns
t _r	Turn-on rise time	$V_{GS} = 10 \text{ V}; R_{G} = 5.6 \Omega$	-	15	-	ns
t _{d off}	Turn-off delay time	Resistive load	-	20	-	ns
t _f	Turn-off fall time		-	10	-	ns
L _d	Internal drain inductance	Measured tab to centre of die	-	2.5	-	nΗ
Ls	Internal source inductance	Measured from source lead to source	-	5	-	nH
		bond pad				
C _{iss}	Input capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 25 \text{ V}; f = 1 \text{ MHz}$	-	633	-	pF
Coss	Output capacitance	, 55 ,	-	103	-	pF
C _{rss}	Feedback capacitance		-	61	-	pF

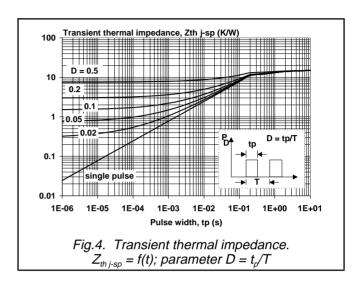
REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS

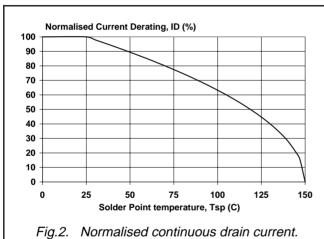
 $T_i = 25^{\circ}C$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Is	Continuous source current (body diode)	$T_{sp} = 25 ^{\circ}C$	-	-	5.5	Α
I _{SM}	Pulsed source current (body diode)		-	-	26	Α
V_{SD}	Diode forward voltage	$I_F = 6 \text{ A}; V_{GS} = 0 \text{ V}$	-	0.8	1.2	V
t _{rr} Q _{rr}	Reverse recovery time Reverse recovery charge	$I_F = 6 \text{ A}; -dI_F/dt = 100 \text{ A/}\mu\text{s};$ $V_{GS} = 0 \text{ V}; V_R = 25 \text{ V}$	-	55 135	-	ns nC

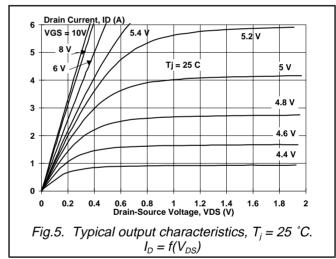
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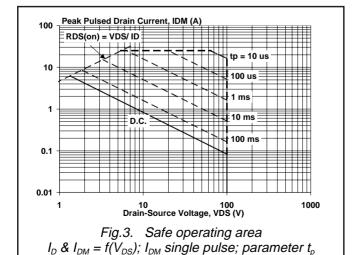


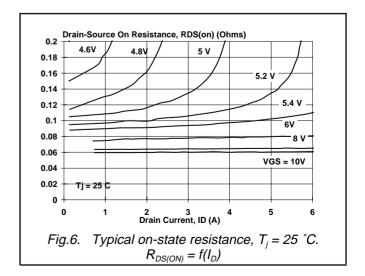




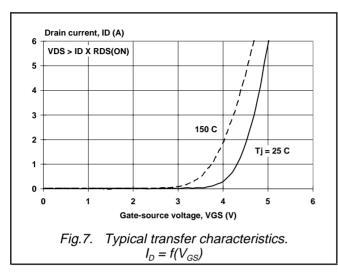
 $ID\% = 100 \cdot I_D / I_{D.25 \, ^{\circ}C} = f(T_{sp}); \ V_{GS} \ge 10 \ V$

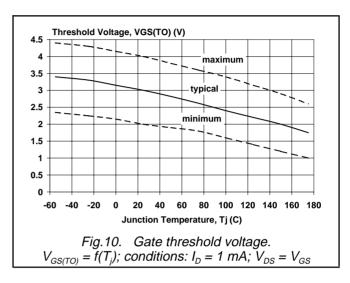


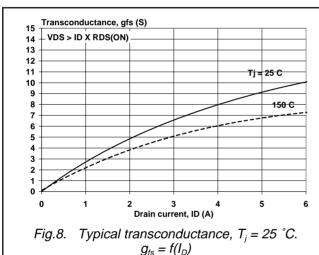


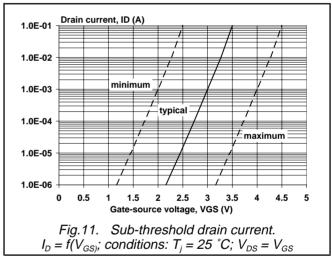


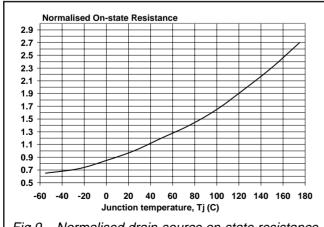
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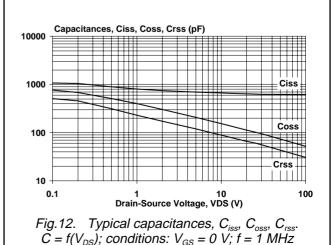


Fig. 9. Normalised drain-source on-state resistance. $R_{DS(ON)}/R_{DS(ON)25\ C} = f(T_j)$ Fig. 12. Typical capacitances, C_{iss} , C_{oss} , C_{rss} . $C = f(V_{DS})$; conditions: $V_{GS} = 0\ V$; $f = 1\ MHz$

PHT6NQ10T

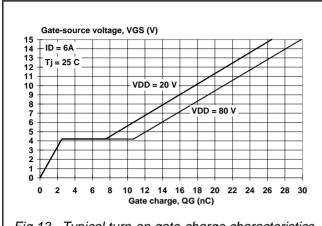
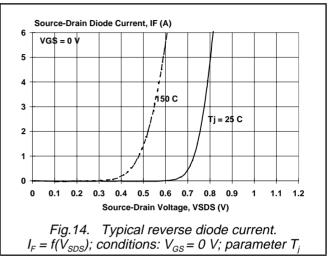
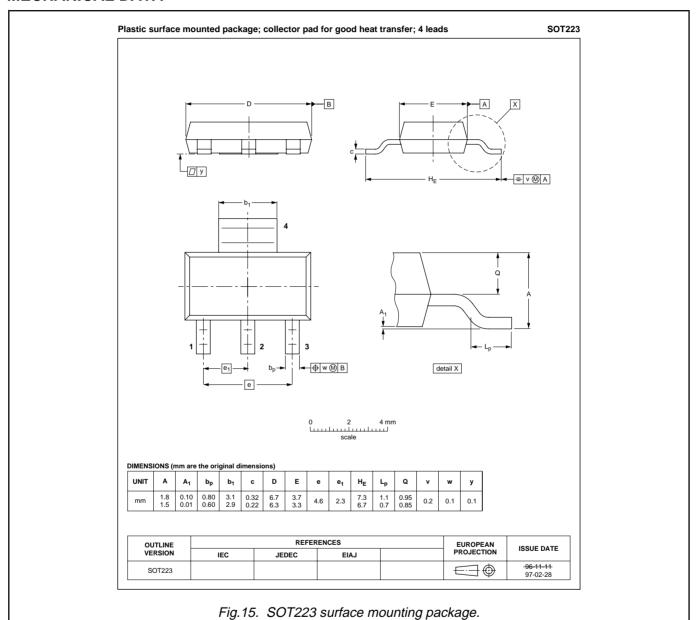


Fig.13. Typical turn-on gate-charge characteristics. $V_{\rm GS} = f(Q_{\rm G})$



PHT6NQ10T

MECHANICAL DATA



Notes

- 1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
- 2. Refer to Discrete Semiconductor Packages, Data Handbook SC18.
- 3. Epoxy meets UL94 V0 at 1/8".

Philips Semiconductors Product specification

N-channel TrenchMOSTM transistor

PHT6NQ10T

DEFINITIONS

Data sheet status				
Objective specification	This data sheet contains target or goal specifications for product development.			
Preliminary specification This data sheet contains preliminary data; supplementary data may be published late				
Product specification This data sheet contains final product specifications.				
Limiting values				

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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